Ultra-Low VF Schottky Rectifier, 20 A, 100 V

FSV20100V

Features

- Ultra–Low Forward Voltage Drop
- Low Thermal Resistance
- Very Low Profile: Typical Height of 1.1 mm
- Trench Schottky Technology
- Green Molding Compound as per IEC61249 Standard
- Non–DAP Option Only
- These Devices are Pb–Free, Halogen Free Free and are RoHS Compliant

Specifications

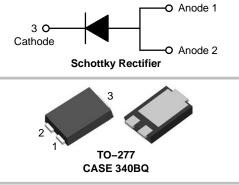
| Symbol | pol Rating | | Unit |
|--------------------|--|---------------------------|------|
| V _{RRM} | Peak Repetitive Reverse Voltage | 100 | V |
| V _{RWM} | M Working Peak Reverse Voltage 100 | | V |
| V _{RMS} | RMS Reverse Voltage 70 | | V |
| V _R | DC Blocking Voltage | 100 | V |
| I _{F(AV)} | Average Rectified Peak Forward Surge Current | 20 | A |
| I _{FSM} | Non–Repetitive Peak Forward Surge 270 Current 270 | | A |
| TJ | Operating Junction Temperature Range | erature Range -55 to +150 | |
| T _{STG} | Storage Temperature Range | -55 to +150 | °C |

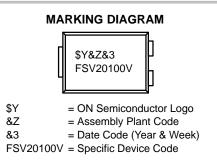
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

FSV20100V

THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Note 1)

| Symbol | Characteristic | Minimum Land Pattern | Maximum Land Pattern | Unit |
|-----------------|--|-------------------------|-------------------------|------|
| $R_{\theta JA}$ | Junction-to-Ambient Thermal Resistance | 100 | 40 | °C/W |
| Ψ_{JL} | Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Anode | 15 | 12 | °C/W |
| | Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Cathode | 6 | 5 | |

 The thermal resistances (R_{θJA} & Ψ_{JL}) are characterized with device mounted on the following FR4 printed circuit boards, as shown in Figure 1 and Figure 2. PCB size: 76.2 x 114.3 mm. Minimum land pattern size: 4.9 x 4.8 mm (big pattern, x1), 1.4 x 1.52 mm (small pattern, x2). Maximum land pattern size: 30 x 30 mm (pattern, x2). Force line trace size = 55 mils, sense line trace size = 4 mils.



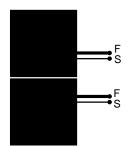


Figure 1. Minimum Land Pattern of 2 oz Copper

Figure 2. Maximum Land Pattern of 2 oz Copper

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|----------------------|-------------------------|-----|-----|------|------|
| BV _R | Breakdown Voltage | I _R = 0.5 mA | 100 | - | - | V |
| V _F | Forward Voltage Drop | I _F = 20 A | - | - | 0.66 | V |
| I _R | Reverse Current | V _R = 100 V | _ | - | 80 | μΑ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

| Part Number | Top Mark | Package | Shipping [†] |
|-------------|-----------|-------------------------------------|-----------------------|
| FSV20100V | FSV20100V | TO–277 3L (Pb–Free/Halogen Free) | 5000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

FSV20100V

TYPICAL PERFORMANCE CHARACTERISTICS

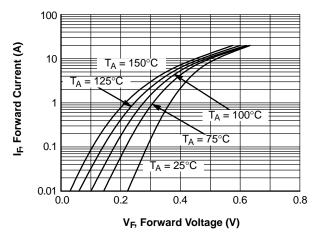


Figure 3. Typical Forward Characteristics

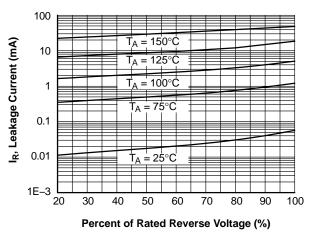


Figure 4. Typical Reverse Characteristics

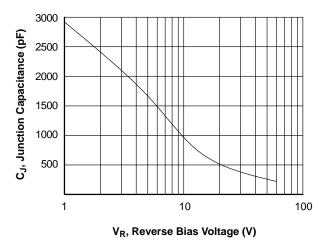


Figure 5. Typical Junction Capacitance

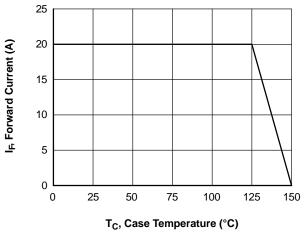
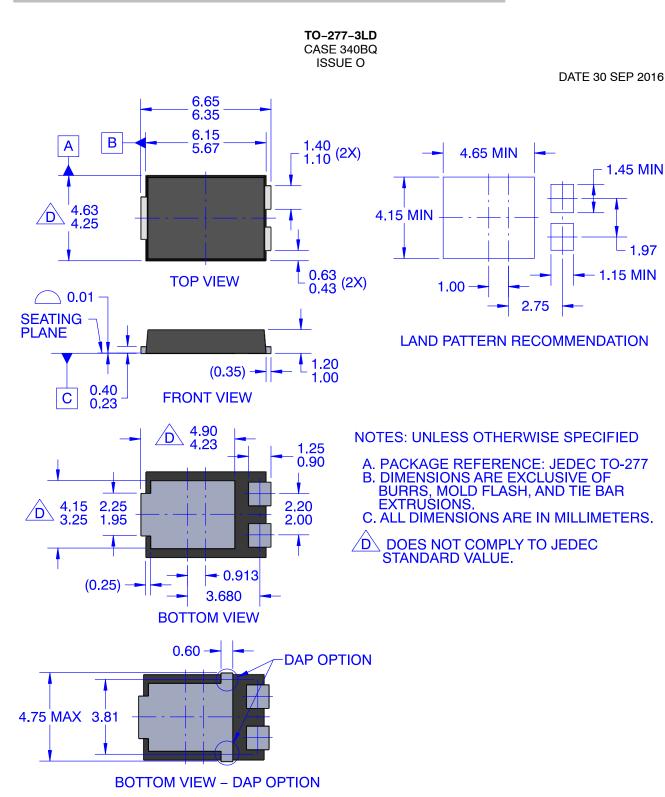


Figure 6. Forward Current Derating Curve





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